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Product Change Notification - JAON-26BUWR464

(Printer Friendly)

Date: 27 Sep 2017 **Product** Memory

Category:

Notification CCB 2729 Final Notice: Qualification of HR-9004 die attach

subject: material for selected products available in 8L USON

(2x3x0.6mm) package at LPI assembly site.

PCN Status: Notification text:

Final notification

Microchip Parts Affected:

Please open the attachments found in the attachments field below labeled as PCN # Affected CPN.

NOTE: For your convenience Microchip includes identical

files in two formats (.pdf and .xls).

Description of Change:

Qualification of HR-9004 die attach material for selected products available in 8L USON (2x3x0.6mm) package at LPI

assembly site.

Pre Change:

Using EM-700J die attach material.

Post Change:

Using EM-700 or HR-9004 die attach material

Pre and Post Change Summary:

	Pre Change	Post Change
Assembly Site	LPI assembly site	LPI assembly site

Wire material	Au wire	Au wire		
Die attach material	EM-700J	EM- 700J	HR- 9004	
Molding compound material	G770HT	G770HT		
Lead frame material	C7025	C7025		

Impacts to Data Sheet:

None

Change Impact:

None

Reason for Change:To improve on-time delivery performance by qualifying HR-9004 die attach material.

Change Implementation Status:

In Progress

Estimated First Ship Date:

October 27, 2017 (date code: 1743)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	September 2017				October 2017				
Workweek	35	36	37	38	39	40	41	42	43
Qual Report Availability					Χ				
Final PCN Issue Date					Χ				
Estimated Implementation Date									X

Method to Identify Change:

Traceability code

Qualification Report:

Please open the attachments included with this PCN labeled as PCN_#_Qual Report.

Revision History:

September 27, 2017: Issued final notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s): PCN_JAON-26BUWR464_Qual_Report.pdf

PCN_JAON-26BUWR464_Affected_CPN.pdf PCN_JAON-26BUWR464_Affected_CPN.xls

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